



SCCS027B - August 1994 - Revised September 2001

CY74FCT16240T CY74FCT162240T

16-Bit Buffers/Line Drivers

Features

- I_{off} supports partial-power-down mode operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of -40°C to $+85^{\circ}\text{C}$
- $V_{CC} = 5\text{V} \pm 10\%$

CY74FCT16240T Features:

- 64 mA sink current, 32 mA source current
- Typical V_{OLP} (ground bounce)
<1.0V at $V_{CC} = 5\text{V}$, $T_A = 25^{\circ}\text{C}$

CY74FCT162240T Features:

- Balanced output drivers: 24 mA
- Reduced system switching noise
- Typical V_{OLP} (ground bounce)
<0.6V at $V_{CC} = 5\text{V}$, $T_A = 25^{\circ}\text{C}$

Functional Description

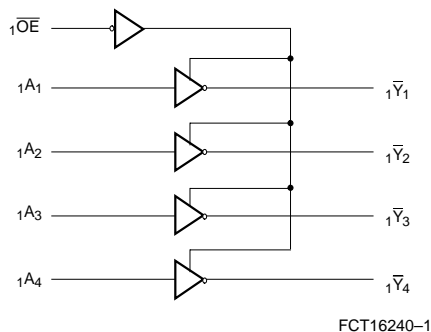
These 16-bit buffer/line drivers are used in memory driver, clock driver, or other bus interface applications, where high speed and low power are required. With flow-through pinout and small shrink packaging, board layout is simplified. The three-state controls are designed to allow 4-, 8-, or 16-bit operation.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

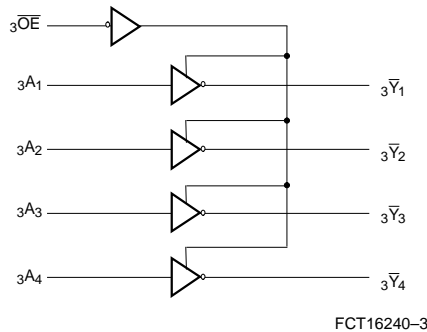
The CY74FCT16240T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162240T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162240T is ideal for driving transmission lines.

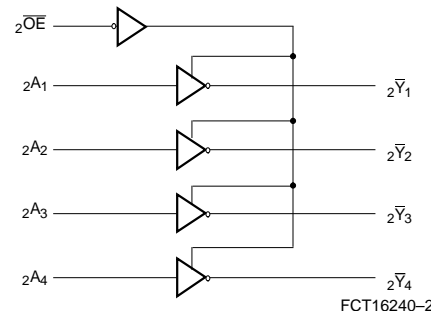
Logic Block Diagrams



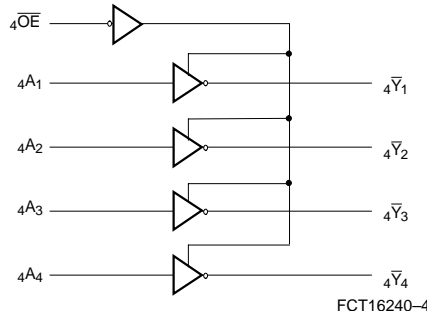
FCT16240-1



FCT16240-3

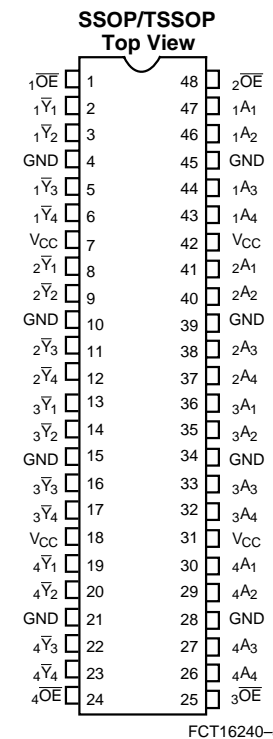


FCT16240-2



FCT16240-4

Pin Configuration



FCT16240-5

Pin Summary

Name	Description
OE	Three-State Output Enable Inputs (Active LOW)
A	Data Inputs
Y	Three-State Outputs

Function Table^[1]

Inputs		Outputs
OE	A	Y
L	L	H
L	H	L
H	X	Z

Maximum Ratings^[2, 3]

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage TemperatureCom'l. -55°C to +125°C

Ambient Temperature with

Power Applied.....Com'l. -55°C to +125°C

DC Input Voltage -0.5V to +7.0V

DC Output Voltage..... -0.5V to +7.0V

DC Output Current

(Maximum Sink Current/Pin) -60 to +120 mA

Power Dissipation 1.0W

Static Discharge Voltage

(per MIL-STD-883, Method 3015) >2001V

Operating Range

Range	Ambient Temperature	V _{CC}
Industrial	-40°C to +85°C	5V ± 10%

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Typ. ^[4]	Max.	Unit
V _{IH}	Input HIGH Voltage		2.0			V
V _{IL}	Input LOW Voltage				0.8	V
V _H	Input Hysteresis ^[5]			100		mV
V _{IK}	Input Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18 mA		-0.7	-1.2	V
I _{IH}	Input HIGH Current	V _{CC} = Max., V _I = V _{CC}			±1	μA
I _{IH}	Input HIGH Current	V _{CC} = Max., V _I = V _{CC}			±1	μA
I _{IL}	Input LOW Current	V _{CC} = Max., V _I = GND			±1	μA
I _{IL}	Input LOW Current	V _{CC} = Max., V _I = GND			±1	μA
I _{OZH}	High Impedance Output Current (Three-State Output pins)	V _{CC} = Max., V _{OUT} = 2.7V			±1	μA
I _{OZL}	High Impedance Output Current (Three-State Output pins)	V _{CC} = Max., V _{OUT} = 0.5V			±1	μA
I _{OS}	Short Circuit Current ^[6]	V _{CC} = Max., V _{OUT} = GND	-80	-140	-200	mA
I _O	Output Drive Current ^[6]	V _{CC} = Max., V _{OUT} = 2.5V	-50		-180	mA
I _{OFF}	Power-Off Disable	V _{CC} = 0V, V _{OUT} ≤ 4.5V ^[7]			±1	μA

Output Drive Characteristics for CY74FCT16240T

Parameter	Description	Test Conditions	Min.	Typ. ^[4]	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -3 mA	2.5	3.5		V
		V _{CC} = Min., I _{OH} = -15 mA	2.4	3.5		V
		V _{CC} = Min., I _{OH} = -32 mA	2.0	3.0		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 64 mA		0.2	0.55	V

Notes:

1. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = High Impedance.
2. Operation beyond the limits set forth may impair the useful life of the device. Unless noted, these limits are over the operating free-air temperature range.
3. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.
4. Typical values are at V_{CC} = 5.0V, T_A = +25°C ambient.
5. This parameter is specified but not tested.
6. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.
7. Tested at +25°C.

Output Drive Characteristics for CY74FCT162240T

Parameter	Description	Test Conditions	Min.	Typ. ^[4]	Max.	Unit
I_{ODL}	Output LOW Current ^[6]	$V_{CC} = 5V$, $V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5V$	60	115	150	mA
I_{ODH}	Output HIGH Current ^[6]	$V_{CC} = 5V$, $V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5V$	-60	-115	-150	mA
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$, $I_{OH} = -24 \text{ mA}$	2.4	3.3		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$, $I_{OL} = 24 \text{ mA}$		0.3	0.55	V

Capacitance^[5] ($T_A = +25^\circ\text{C}$, $f = 1.0 \text{ MHz}$)

Parameter	Description	Test Conditions	Typ. ^[4]	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 0V$	4.5	6.0	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0V$	5.5	8.0	pF

Power Supply Characteristics

Parameter	Description	Test Conditions		Typ. ^[4]	Max.	Unit
I _{CC}	Quiescent Power Supply Current	V _{CC} =Max.	V _{IN} ≤0.2V, V _{IN} ≥V _{CC} −0.2V	5	500	μA
ΔI _{CC}	Quiescent Power Supply Current (TTL inputs HIGH)	V _{CC} =Max.	V _{IN} =3.4V ^[8]	0.5	1.5	mA
I _{CCD}	Dynamic Power Supply Current ^[9]	V _{CC} =Max., One Input Toggling, 50% Duty Cycle, Outputs Open, \overline{OE} =GND	V _{IN} =V _{CC} or V _{IN} =GND	60	100	μA/MHz
I _C	Total Power Supply Current ^[10]	V _{CC} =Max., f ₁ =10 MHz, 50% Duty Cycle, Outputs Open, One Bit Toggling, \overline{OE} =GND	V _{IN} =V _{CC} or V _{IN} =GND	0.6	1.5	mA
			V _{IN} =3.4V or V _{IN} =GND	0.9	2.3	mA
		V _{CC} =Max., f ₁ =2.5 MHz, 50% Duty Cycle, Outputs Open, Sixteen Bits Toggling, \overline{OE} =GND	V _{IN} =V _{CC} or V _{IN} =GND	2.4	4.5 ^[11]	mA
			V _{IN} =3.4V or V _{IN} =GND	6.4	16.5 ^[11]	mA

Notes:

8. Per TTL driven input ($V_{IN} = 3.4V$); all other inputs at V_{CC} or GND.
9. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
10. $I_C = I_{\text{QUIESCENT}} + I_{\text{INPUTS}} + I_{\text{DYNAMIC}}$
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_0/2 + f_1 N_1)$
 I_{CC} = Quiescent Current with CMOS input levels
 ΔI_{CC} = Power Supply Current for a TTL HIGH input ($V_{IN} = 3.4V$)
 D_H = Duty Cycle for TTL inputs HIGH
 N_T = Number of TTL inputs at D_H
 I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL)
 f_0 = Clock frequency for registered devices, otherwise zero
 f_1 = Input signal frequency
 N_1 = Number of inputs changing at f_1
All currents are in milliamps and all frequencies are in megahertz.
11. Values for these conditions are examples of the I_{CC} formula. These limits are specified but not tested.

Switching Characteristics Over the Operating Range^[12]

Parameter	Description	CY74FCT16240AT		CY74FCT162240CT		Unit	Fig. No. ^[13]
		Min.	Max.	Min.	Max.		
t _{PLH} t _{PHL}	Propagation Delay Data to Output	1.5	4.8	1.5	4.3	ns	1, 2
t _{PZH} t _{PZL}	Output Enable Time	1.5	6.2	1.5	5.8	ns	1, 7, 8
t _{PHZ} t _{PLZ}	Output Disable Time	1.5	5.6	1.5	5.2	ns	1, 7, 8
t _{SK(O)}	Output Skew ^[14]		0.5		0.5	ns	—

Note:

12. Minimum limits are specified but not tested on Propagation Delays.

13. See "Parameter Measurement Information" in the General Information section.

14. Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

Ordering Information CY74FCT16240

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.8	CY74FCT16240ATPVC/PVCT	O48	48-Lead (300-Mil) SSOP	Industrial

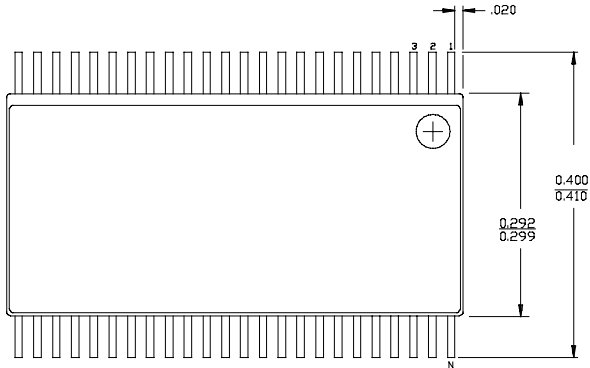
Ordering Information CY74FCT162240

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.3	74FCT162240CTPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162240CTPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162240CTPVCT	O48	48-Lead (300-Mil) SSOP	

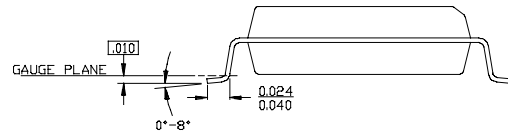
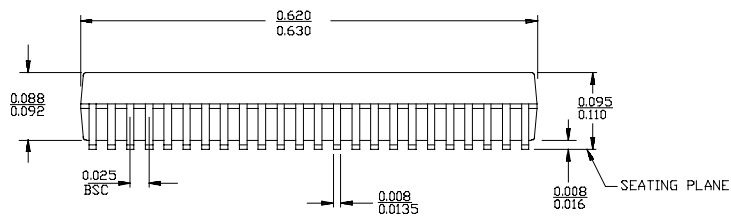
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Package Diagrams

48-Lead Shrunk Small Outline Package O48

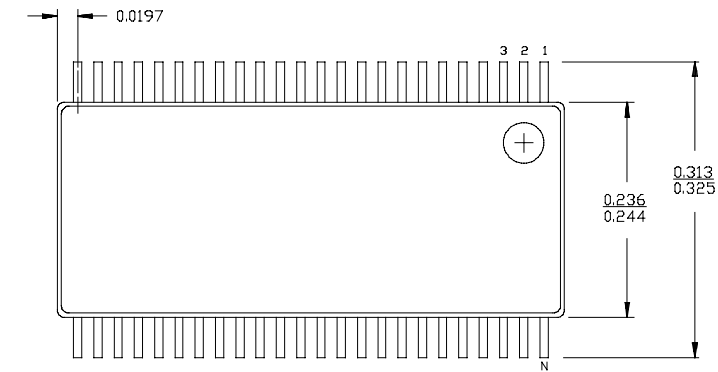


DIMENSIONS IN INCHES MIN.
MAX.

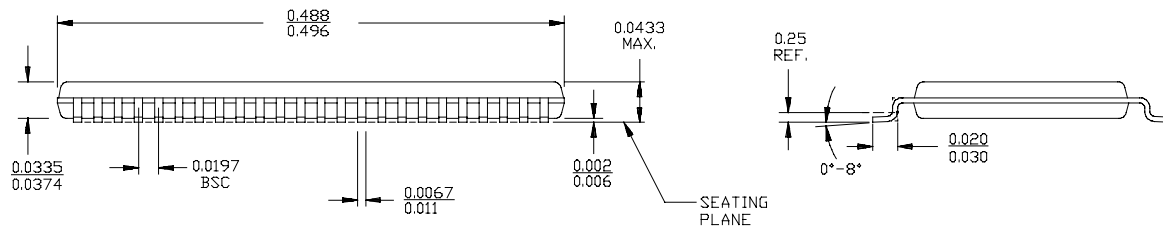


Package Diagrams

48-Lead Thin Shrink Small Outline Package



DIMENSIONS IN INCHES MIN.
MAX.



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